Call for Papers International Symposium on Mobile Computing (MC'06)

MC'06

Web Site http://lia.deis.unibo.it/Staff/PaoloBellavista/mc06/ Toronto, Canada, ??-??, 2006

within the International Conference on Wireless Networks, Communications, and Mobile Computing (WirelessCom'06, <u>http://www.wirelesscom2006.org</u>)

Recent years have witnessed an enormous growth in the development and applications of mobile computing environments and devices. Many practitioners envision a future empowered with context- and location-aware computation and communication infrastructures that allow users to access data and services at any place and any time. Compared to conventional platforms, the mobility of computing nodes introduces many challenges to the design of almost all systems components.

This symposium will foster a forum for discussing and presenting recent research results on mobile computing systems. Original papers are invited in the broader area of mobile computing. Papers must report high-quality and previously unpublished work. Topics of interest include, but are not limited to, the following:

- Adaptive resource management
- Architecture and infrastructure support
- Context-aware computing
- Data consistency and synchronization protocols
- Development platforms and environments
- Efficient localization techniques

- Emerging mobile applications
- Middleware
- Mobile agents
- Mobile commerce
- Mobile peer to peer
- Operating system support for mobile computing
- Performance metrics and studies
- Pervasive computing
- Power-aware computing and communication
- Quality of service
- Robust ad-hoc networking techniques
- Security and privacy issues
- Time-constrained mobile systems
- Wearable computing devices and systems
- Web caching and services
- Wireless sensor networks

PAPER SUBMISSION

Original papers are solicited and must represent high-quality and previously unpublished work, not currently under review by another conference or journal. Prospective authors should submit their paper electronically through the general **WirelessCom'06 submission server** (<u>http://www.wirelesscom2006.org/submission.htm</u></u>). All papers are limited to 6 pages in standard IEEE double-column format. Emails and hard copies will be accepted only if motivated reasons prevent electronic submission. In that case, contact first the Technical Chair:

Paolo Bellavista

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January 6, 2006

Important Dates:

Paper submission deadline

March 10, 2006 Notification of acceptance April 7, 2006 Final camera-ready manuscripts due TECHNICAL PROGRAM COMMITTEE (to be confirmed) T. Magedanz, Fraunhofer Fokus, Germany A. Abdel-Hamid, Arab Acad Science and Technology, Egypt P. Mundur, Univ Maryland Baltimore County, USA E. Aboelela, Univ Massachusetts Dartmouth, USA T. Nadeem, Univ Maryland College Park, USA . M. Bassiouni, Univ Central Florida, USA • S. Nair, Southern Methodist Univ, USA L. Benmohamed, Applied Physics Lab, USA S. Olariu, Old Dominion Univ, USA E. Cavirci, Istanbul Technical University, Turkey C. Pinotti, Univ Perugia, Italy . A. Corradi, Univ Bologna, Italy • F. Perich, Cougaar Software Inc., USA A. Durresi, Louisiana State Univ, USA . • D. Qiao, Iowa State Univ, USA . S. Elsharkawy, Catholic Univ of America, USA . D. Rajan, Southern Methodist Univ, USA H. Ferhatosmanoglu, Ohio State Univ, USA . S. Russo, Univ Napoli Federico II, Italy D. Gracanin, Virginia Tech, USA A. Selcuk, Bilkent Univ, Turkey B. Gu, Virginia Tech, USA • K. Shuaib, UAE Univ, UAE . M. Hefeeda, Simon Fraser Univ, Canada I. Stojmenovic, Univ Ottawa, Canada M. Hinchey, NASA, USA J. Thomas, Univ Maryland Baltimore County, USA I. Kamel, Zayed Univ, UAE A. Youssef, Univ Maryland College Park, USA A. Kassler, Karlstad Univ, Sweden . M. Youssef, Univ Maryland College Park, USA D. Kim, Information and Communication Univ, Korea • A. Y. Zomaya, Univ Sydney, Australia T. Korkmaz, Univ Texas at San Antonio, USA